

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Technical Data Sheet

Chip LED with Right Angle Lens

12-215UBC/C430/TR8

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

Descriptions

- The 12-215 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Everlight Electronics Co., Ltd.

Part No.	Chip	Emitted Color	Resin Color	
	Material	Emitted Color		
12-215UBC/C430/TR8	InGaN	Blue	Water Clear	



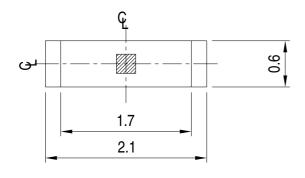
Device No.: DSE-125-019 Prepared date: 6-Apr-2009 Prepared by: Huang yongxin

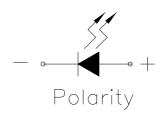
http://www.everlight.com

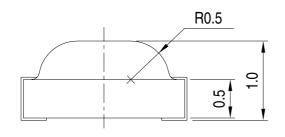
Rev.1

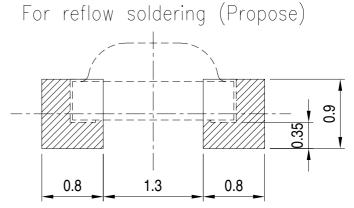
Page: 1 of 9

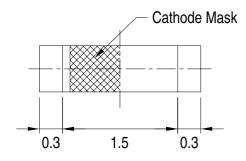
Package Outline Dimensions











Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd.

Device No.: DSE-125-019

http://www.everlight.com

Prepared date: 6-Apr-2009

Rev.1

Page: 2 of 9

Prepared by: Huang yongxin

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	VR	5	V
Forward Current	I_{F}	30	mA
Peak Forward Current (Duty 1/10 @1KHz)	$ m I_{FP}$	70	mA
Power Dissipation	Pd	130	mW
Electrostatic Discharge(HBM)	ESD	1000	V
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.	

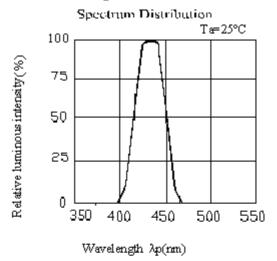
Electro-Optical Characteristics (Ta=25°C)

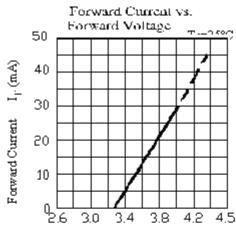
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Luminous Intensity	Iv	18	22		mcd		
Viewing Angle	2 θ 1/2		130		deg		
Peak Wavelength	λp		428		nm		
Dominant Wavelength	λd		466		nm	IF=20mA	
Spectrum Radiation Bandwidth	Δλ		65		nm		
Forward Voltage	VF		3.8	4.5	V		
Reverse Current	IR			50	μ A	V _R =5V	

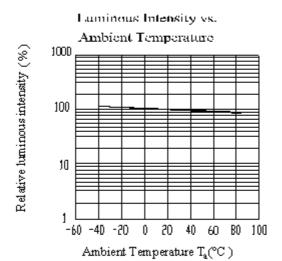
Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 3 of 9

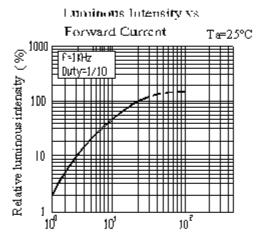
Device No.: DSE-125-019 Prepared date: 6-Apr-2009 Prepared by: Huang yongxin

Typical Electro-Optical Characteristics Curves



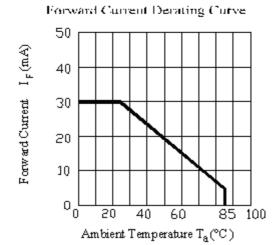


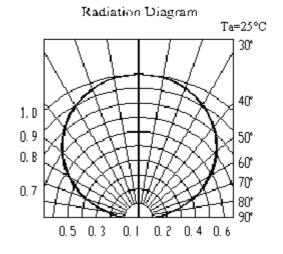




Forward Current Ip (mA)

Forward Voltage $V_F(V)$





Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 4 of 9

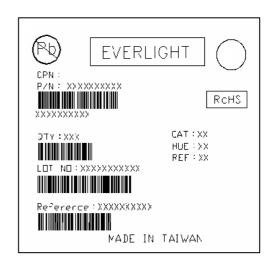
Device No.: DSE-125-019 Prepared date: 6-Apr-2009 Prepared by: Huang yongxin

Lbel explanation

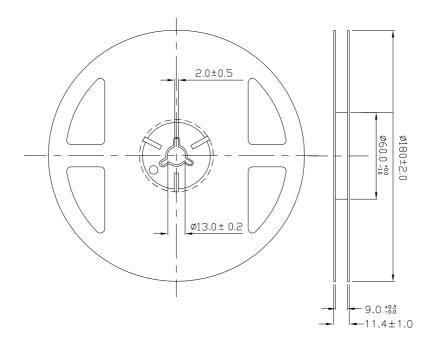
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions

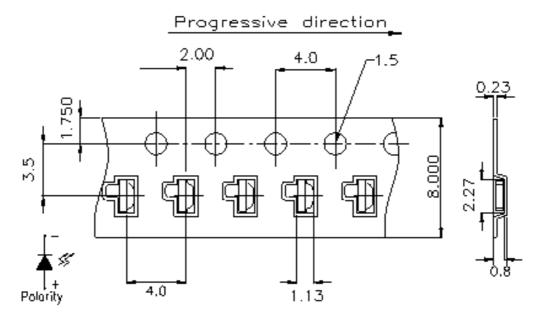


Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 5 of 9

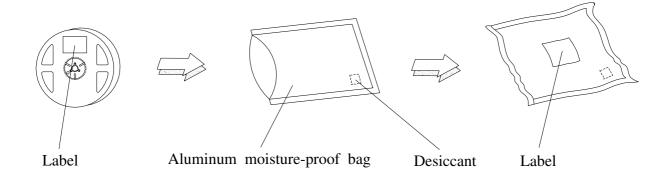
Device No.: DSE-125-019 Prepared date: 6-Apr-2009 Prepared by: Huang yongxin

Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 6 of 9

Device No. : DSE-125-019 Prepared date: 6-Apr-2009 Prepared by: Huang yongxin



Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 7 of 9

Device No.: DSE-125-019 Prepared date: 6-Apr-2009 Prepared by: Huang yongxin

Precautions For Use

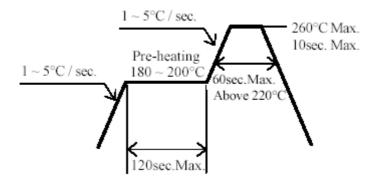
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
 - 2.3 After opening the package, the LEDs should be kept at 30° C or less and 70%RH or less.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 8 of 9

Device No.: DSE-125-019 Prepared date: 6-Apr-2009 Prepared by: Huang yongxin

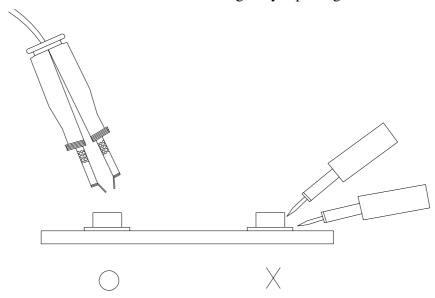


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev.1 Page: 9 of 9

Device No.: DSE-125-019 Prepared date: 6-Apr-2009 Prepared by: Huang yongxin